TE Internal #: 2199075-2

PCB Mount Compression Connector, Vertical, Board-to-Board, 4

Position, 1.6 mm [.063 in] Centerline, Gold (Au), Surface Mount,

Power & Signal, Black

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PCB Connector Type: PCB Mount Compression Connector

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 4
Number of Rows: 2

Features

Product Type Features

PCB Connector Type	PCB Mount Compression Connector
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Connector Product Type	Connector Assembly

Configuration Features

PCB Mount Orientation	Vertical
Number of Positions	4
Number of Rows	2

Body Features

Contact Features

Contact Base Material	Copper Alloy
PCB Contact Termination Area Plating Material	Gold Flash



Contact Mating Area Plating Material Thickness	.1 – .2 μm[3.937 – 7.87 μin]
Contact Mating Area Plating Material	Gold (Au)
Contact Type	Pin
Contact Current Rating (Max)	.3 A
Termination Features	
Termination Method to PCB	Surface Mount
Mechanical Attachment	
Connector Mounting Type	Board Mount
Housing Features	
Housing Material	High Temperature Thermoplastic
Centerline (Pitch)	1.6 mm[.063 in]
Dimensions	
Profile Height from PCB	1.65 mm[.065 in]
Usage Conditions	
Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]
Operation/Application	
Circuit Application	Power & Signal
Packaging Features	
Packaging Quantity	3500
	T 0.D 1

Product Compliance

Packaging Method

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Tape & Reel



Solder Process Capability

Wave solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Customers Also Bought























Documents

Product Drawings

4POS 1.6P 1.65H BTB CONN

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2199075-2_6.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2199075-2_6.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2199075-2_6.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

1-1773729-8_compressiveBTB_EN

English

1-1773731-8-compressiveBTB_CN_201403

Product Specifications

Product Specification

English